# GP2S700HCP

#### Features

- 1. Ultra compact SMD package
- 2. Long focal distance type (focal distance:3mm)
- 3. Effective detection distance: 1.2 to 5.5mm

### Applications

- 1. Copiers
- 2. Facsimiles
- 3. Printers

Absolute Maximum Ratings $(T_a=25^{\circ}C)$									
	Parameter	Symbol	Rating	Unit					
Input	Forward current	I <sub>F</sub>	50	mA					
	Reverse voltage	V <sub>R</sub>	6	V					
	Power dissipation	PD	75	mW					
Output	Collector-emitter voltage	V <sub>CEO</sub>	35	V					
	Emitter-collector voltage	V <sub>ECO</sub>	6	V					
	Collector current	I <sub>C</sub>	20	mA					
	Collector power dissipation	P <sub>C</sub>	75	mW					
5	Total power dissipation	P <sub>tot</sub>	100	mW					
(	Operating temperature	Topr	-25 to +85	°C /					
Ş	Storage temperature	T <sub>stg</sub>	-40 to +100	°C					
*1 Soldering temperature		T <sub>sol</sub>	260	/°e~/					
*1 F	for 5s								
		$\langle \rangle$	$\frown$						

# Long Focal Distance, Subminiature Photointerrupter

Outline Dimensions (Unit : mm) Detecter center 2 XD (0.8)  $\nabla$ (T) 2 2 (4) ÷ ĉ Optical center ① Anode 2 Emitter 4 ③ Collector (0.8) Emitter center ④ Cathode (0.25)Note 3) (0.93) 0 (0.93) Note) 1) Unspecified tolerance:±0.3mm 2) ():Reference dimensions 3) There are cases that the obligue line portions may not be filled with epoxy resin. Recommended circuit pattern 4.5 1.2 :-3.5 Pattern wiring is not allowed on obligue line portion not to cause short-circuit.

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## Electro-optical Characteristics

■ Electro-optical Characteristics (T <sub>a</sub> =25°C)											
Parameter			Symbol	Conditions	MIN.	TYP.	MAX. Unit				
Input	Forward vol	tage	V <sub>F</sub>	I <sub>F</sub> =20mA	-	1.2	1.4 V				
	Reverse curr	rent	I <sub>R</sub>	V <sub>R</sub> =6V	-	-	10 µA				
Output	Collector dark current		I <sub>CEO</sub>	V <sub>CE</sub> =20V	-	1	100 nA				
Transfer charac- teristics	Collector current		I <sub>C</sub>	V <sub>CE</sub> =2V, I <sub>F</sub> =4mA	60	-	410 µÅ				
	*2 Leak current		I <sub>LEAK</sub>	V <sub>CE</sub> =2V, I <sub>F</sub> =4mA	-	- (	700 nA				
	*3 Response time	Rise time	t <sub>r</sub>	$V_{CE}=2V, I_{C}=100\mu A$	-	20	100 μs				
		Fall time	t <sub>f</sub>	$R_L=1\ 000\Omega$ , d=4mm	-	20	100 µs				

\*2 No reflective object

\*3 "d" is glass thickness of reflective mirror

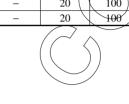
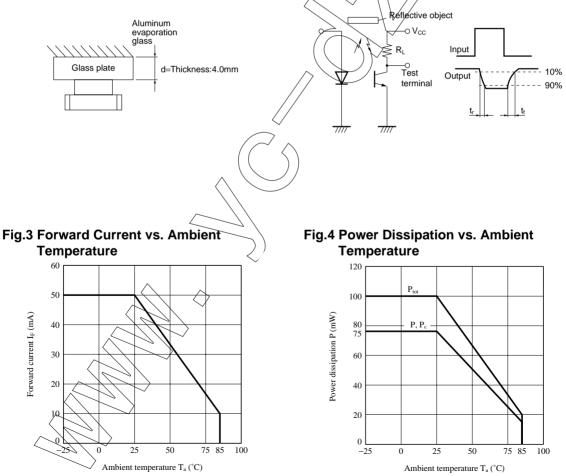
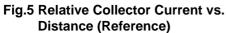
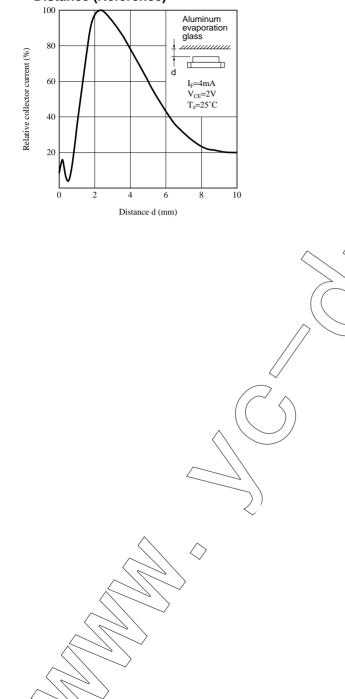


Fig.2 Test Circuit for Response Time

## Fig.1 Measuring Configulation of Collector Current







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